PTO/SB/08A (08-03)

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| | | | | Application Number | | |
| INFO | RMATION | I DISCLOS | SURE | Filing Date | | |
| _ | STATEMENT BY APPLICANT (Use as many sheets as necessary) | | | First Named Inventor | Bing Ji, et al. | |
| (4 | | | | Art Unit | · | |
| | | | | Examiner Name | | |
| Sheet | 1 | of | 2 | Attorney Docket Number | 06299P2 USA | |

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| | | | | Application Number | | |
| | | | | Filing Date | | |
| " | (Use as many sheets as necessary) | | | First Named Inventor | Dingjun Wu, et al. | |
| | (Use as many sn | leels as necess | ary) | Art Unit | | |
| | | | | Examiner Name | | |
| Sheet | 2 | of | 2 | Attorney Docket Number | 06469 USA | |

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